



- MATERIAL:
 HOUSING - HTN NYLON, COLOR: BLACK
 TERMINAL - 0.36[.014] THICK PHOS-BRONZE PLATED WITH 1.27µm[.000050] MINIMUM THICK HARD GOLD IN LOCALIZED GOLD PLATE AREA AND 3.81µm[.000150] MINIMUM THICK MATTE TIN IN SOLDER AREA OVER 1.27µm[.000050] THICK MINIMUM NICKEL UNDERPLATE.
 SHIELD - 0.25[.010] THICK COPPER ALLOY PLATED WITH 3.0µm[.000120] MINIMUM REFLOWED TIN
- CAVITY CONFORMS TO FCC RULES AND REGULATIONS, PART 68, SUBPART F
- DIMENSION MEASURED ALONG FRONT EDGES OF MATING FACE
- BULK PACKAGED IN A TRAY

SUGGESTED PRINTED CIRCUIT BOARD LAYOUT (COMPONENT SIDE)

RECOMMENDED PANEL CUTOUT

5406429-1
PART NO.

THIS DRAWING IS A CONTROLLED DOCUMENT.		DIN: J. ALCORTA - 09/JUN/2005	Tyco Electronics Corporation Tyco Electronics Corporation Harrisburg, Pa 17105-3608	
DIMENSIONS: mm [INCHES]		CHK: J. WESTMAN	APVD: S. FLICKINGER	NAME: MODULAR JACK ASSEMBLY, 8 POSITION, SHIELDED, RIGHT ANGLE WITH PRINTED CIRCUIT BOARD GROUNDS AND PANEL STOPS
TOLERANCES UNLESS OTHERWISE SPECIFIED:		0 PLC ± -	108-1163	APPLICATION SPEC
		1 PLC ± ±	114-2048	SIZE: A1
		2 PLC ± ± 0.13[.005]	00779	SCALE: 4:1
		3 PLC ± ±	5406429	SHEET 1 OF 1
		4 PLC ± ±		REV B
MATERIAL: SEE NOTE 1		FINISH: SEE NOTE 1	WEIGHT: -	CUSTOMER DRAWING

单击下面可查看定价，库存，交付和生命周期等信息

[>>TE Connectivity\(泰科\)](#)